Panasonic

Zener Diode DZ2J062×0L

DZ2J062×0L Silicon epitaxial planar type

For constant voltage / For surge absorption circuit

- Features
- Excellent rising characteristics of zener current Iz •
- · Low zener operating resistance Rz
- · Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: FJ or FU

Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

Absolute Maximum Ratings Ta = 25 °C Parameter Symbol

Parameter	Symbol	Rating	Unit
Repetitive peak forward current	IFRM	200	mA
Total power dissipation ^{*1}	PT	200	mW
Electrostatic discharge *2	ESD	±15	kV
Junction temperature	Tj	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	°C

Isig Note) *1 Mounted on glass epoxy print board ($45~mm \times 45~mm \times 1~mm$) Solder in (Recommended land pattern)

*2 Test method : IEC61000_4_2

(C = 150 pF, R = 330 Ω , Contact discharge : 10 times)

Electrical Characteristics $Ta = 25 \circ C + 3 \circ C$

Electrical Characteristics Ta - 25 C ± 5 C						
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 10 mA			1.0	V
Zener voltage ^{*1, *2}	VZ	IZ = 5 mA	5.89		6.51	V
Zener operating resistance	RZ	IZ = 5 mA			30	Ω
Zener rise operating resistance	RZK	IZ = 0.5 mA			100	Ω
Reverse current	IR	VR = 4 V			0.2	μA
Temperature coefficient of zener voltage *3	SZ	IZ = 5 mA		2.4		mV/°C

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

2. Absolute frequency of input and output is 5 MHz.

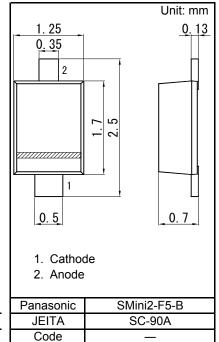
3. *1 The temperature must be controlled 25 °C for VZ mesurement.

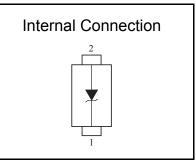
VZ value measured at other temperature must be adjusted to VZ (25 °C).

Rank classifica *2 VZ guaranted 20 ms after current flow

*3 Tj = 25 °C to 150 °C

K Classification				
Code	М	0		
Rank	М	No-rank		
VZ	6.05 to 6.36	5.89 to 6.51		
Marking symbol	FU	FJ		

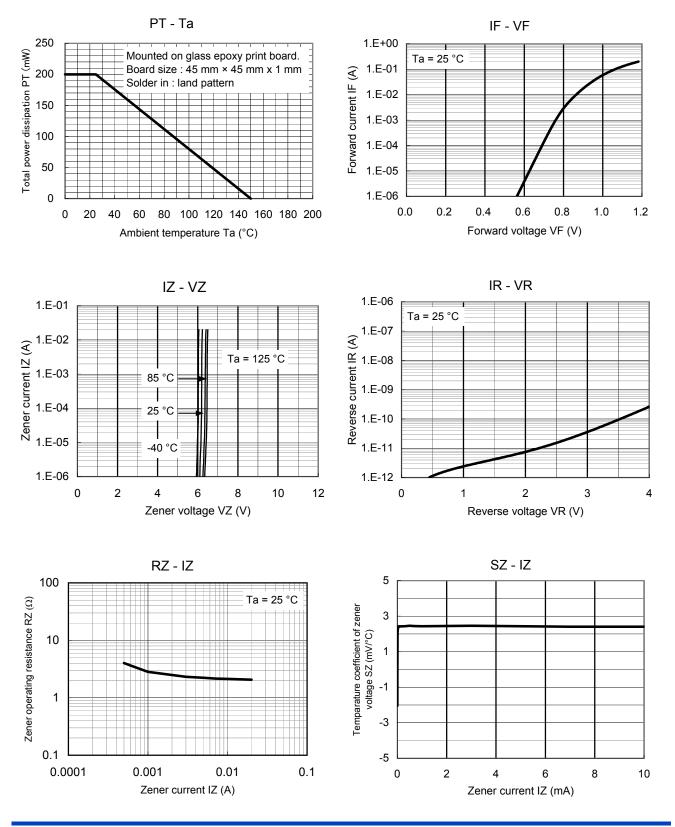






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Technical Data (reference)



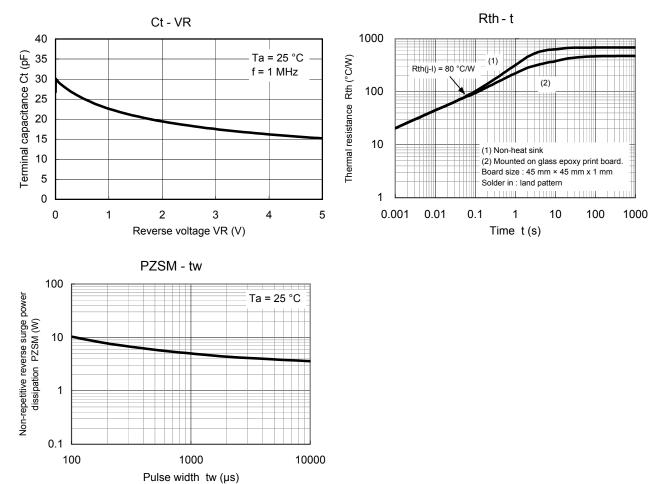
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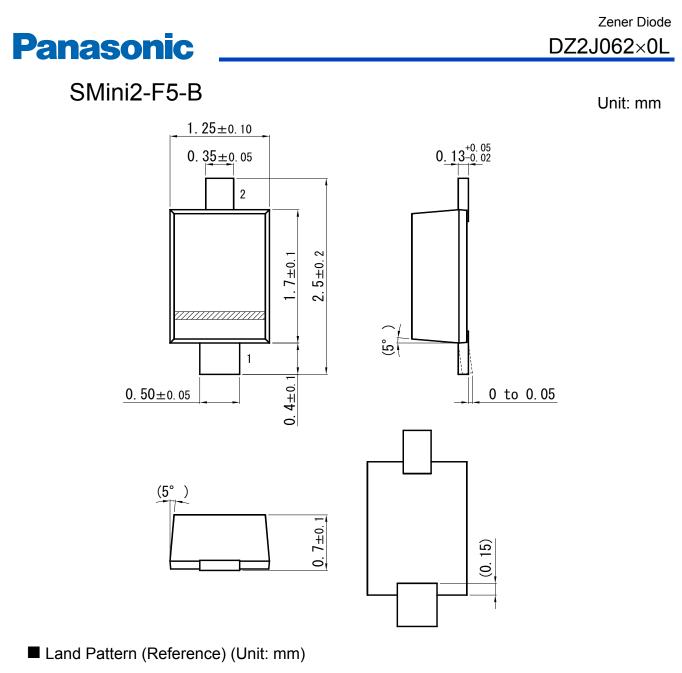
Established : 2009-10-14 Revised : 2013-07-03

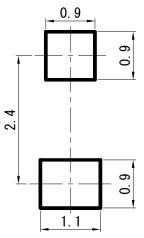


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